

SN54ABT16600, SN74ABT16600 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS209A – JUNE 1992 – REVISED JULY 1994

- **Members of the Texas Instruments Widebus™ Family**
- **State-of-the-Art EPIC-II B™ BiCMOS Design Significantly Reduces Power Dissipation**
- **UBT™ (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015**
- **Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17**
- **Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

description

These 18-bit universal bus transceivers combine D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in each direction is controlled by output-enable (\overline{OEAB} and \overline{OEBA}), latch-enable (\overline{LEAB} and \overline{LEBA}), and clock (\overline{CLKAB} and \overline{CLKBA}) inputs. The clock can be controlled by the clock-enable ($\overline{CLKENAB}$ and $\overline{CLKENBA}$) inputs. For A-to-B data flow, the device operates in the transparent mode when \overline{LEAB} is high. When \overline{LEAB} is low, the A data is latched if \overline{CLKAB} is held at a high or low logic level. If \overline{LEAB} is low, the A-bus data is stored in the latch/flip-flop on the high-to-low transition of \overline{CLKAB} . Output enable \overline{OEAB} is active low. When \overline{OEAB} is low, the outputs are active. When \overline{OEAB} is high, the outputs are in the high-impedance state.

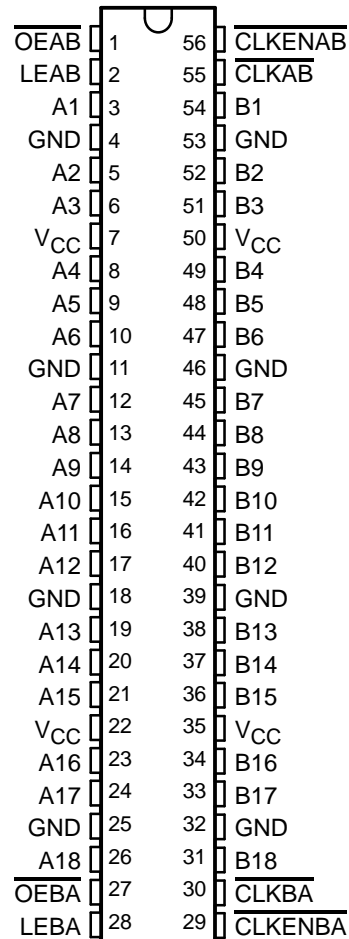
Data flow for B to A is similar to that of A to B but uses \overline{OEBA} , \overline{LEBA} , \overline{CLKBA} , and $\overline{CLKENBA}$.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT16600 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT16600 is characterized over the full military temperature range of -55°C to 125°C . The SN74ABT16600 is characterized for operation from -40°C to 85°C .

SN54ABT16600 . . . WD PACKAGE
SN74ABT16600 . . . DGG OR DL PACKAGE
(TOP VIEW)



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WITH 3-STATE OUTPUTS

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FUNCTION TABLE†

INPUTS					OUTPUT B
$\overline{\text{CLKENAB}}$	$\overline{\text{OEAB}}$	LEAB	$\overline{\text{CLKAB}}$	A	
X	H	X	X	X	Z
X	L	H	X	L	L
X	L	H	X	H	H
H	L	L	X	X	B ₀ ‡
H	L	L	X	X	B ₀ ‡
L	L	L	↓	L	L
L	L	L	↓	H	H
L	L	L	H	X	B ₀ ‡
L	L	L	L	X	B ₀ §

† A-to-B data flow is shown: B-to-A flow is similar but uses $\overline{\text{OEBA}}$, LEBA, CLKBA, and CLKENBA.

‡ Output level before the indicated steady-state input conditions were established.

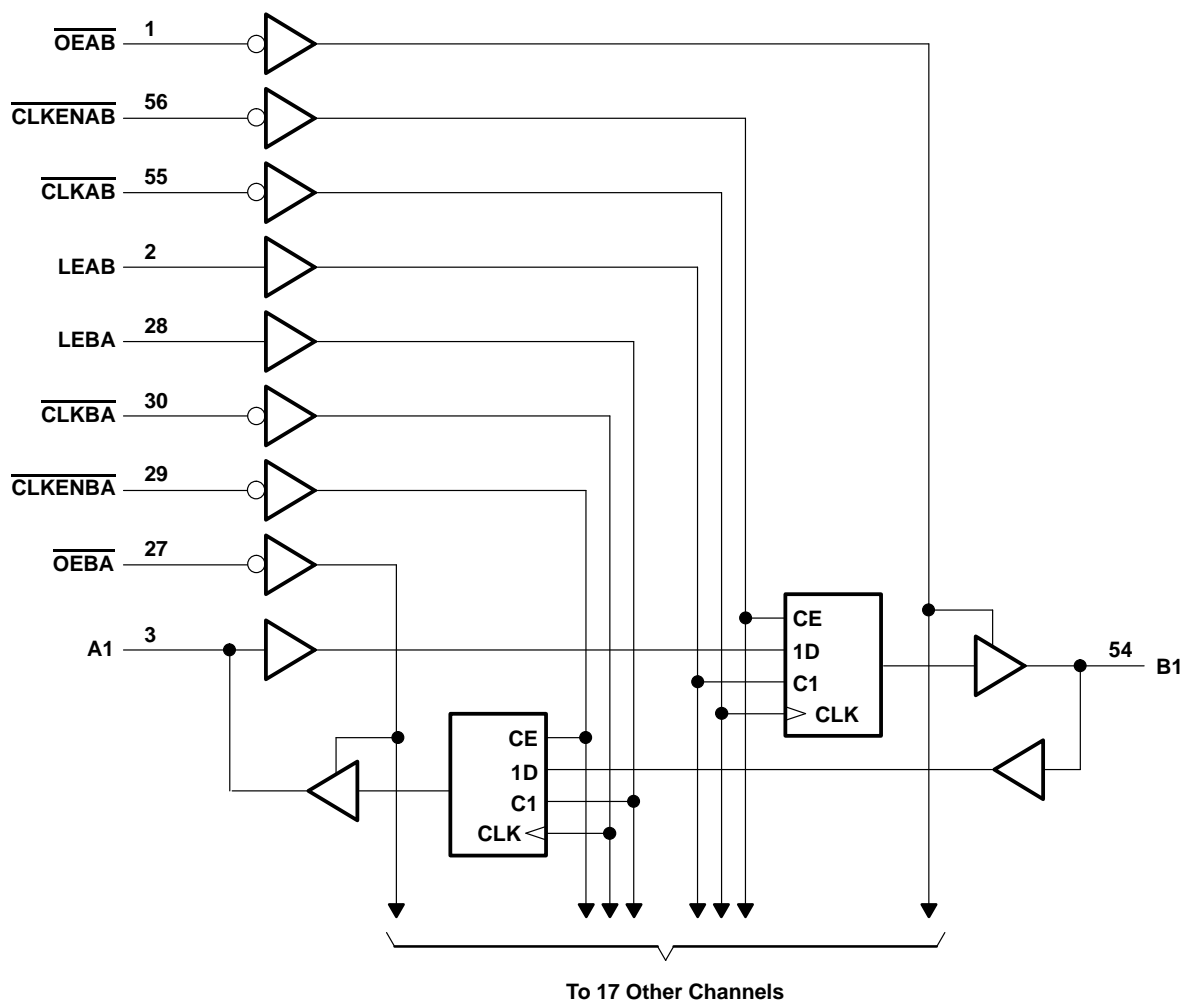
§ Output level before the indicated steady-state input conditions were established, provided that $\overline{\text{CLKAB}}$ was low before LEAB went low.



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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O	–0.5 V to 5.5 V
Current into any output in the low state, I_{OL} : SN54ABT16600	96 mA
SN74ABT16600	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	–18 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DGG package	1 W
DL package	1.4 W
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.



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recommended operating conditions (see Note 3)

			SN54ABT16600		SN74ABT16600		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage			0.8		0.8	V
V_I	Input voltage		0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current			–24		–32	mA
I_{OL}	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
T_A	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused or floating pins (input or I/O) must be held high or low.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	$T_A = 25^\circ\text{C}$			SN54ABT16600		SN74ABT16600		UNIT
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
V_{IK}		$V_{CC} = 4.5\text{ V}$, $I_I = -18\text{ mA}$			–1.2		–1.2		–1.2	V
V_{OH}		$V_{CC} = 4.5\text{ V}$, $I_{OH} = -3\text{ mA}$	2.5			2.5		2.5		V
		$V_{CC} = 5\text{ V}$, $I_{OH} = -3\text{ mA}$	3			3		3		
		$V_{CC} = 4.5\text{ V}$, $I_{OH} = -24\text{ mA}$	2			2				
		$V_{CC} = 4.5\text{ V}$, $I_{OH} = -32\text{ mA}$	2*					2		
V_{OL}		$V_{CC} = 4.5\text{ V}$, $I_{OL} = 48\text{ mA}$			0.55		0.55			V
		$V_{CC} = 4.5\text{ V}$, $I_{OL} = 64\text{ mA}$			0.55*				0.55	
I_I	Control inputs	$V_{CC} = 5.5\text{ V}$, $V_I = V_{CC}$ or GND			± 1		± 1		± 1	μA
	A or B ports				± 20		± 20		± 20	
I_{off}		$V_{CC} = 0$, V_I or $V_O \leq 4.5\text{ V}$			± 100				± 100	μA
I_{CEX}	Outputs high	$V_{CC} = 5.5\text{ V}$, $V_O = 5.5\text{ V}$			50		50		50	μA
I_O^\ddagger		$V_{CC} = 5.5\text{ V}$, $V_O = 2.5\text{ V}$	–50	–100	–180	–50	–180	–50	–180	mA
I_{OZH}^\S		$V_{CC} = 5.5\text{ V}$, $V_O = 2.7\text{ V}$			10		10		10	μA
I_{OZL}^\S		$V_{CC} = 5.5\text{ V}$, $V_O = 0.5\text{ V}$			–10		–10		–10	μA
I_{CC}	A or B ports	$V_{CC} = 5.5\text{ V}$, $I_O = 0$, $V_I = V_{CC}$ or GND			3		3		3	mA
		Outputs high			36		36		36	
		Outputs disabled			3		3		3	
ΔI_{CC}^\P		$V_{CC} = 5.5\text{ V}$, One input at 3.4 V, Other inputs at V_{CC} or GND			50		50		50	μA
C_i	Control inputs	$V_I = 2.5\text{ V}$ or 0.5 V			3					pF
C_{io}	A or B ports	$V_O = 2.5\text{ V}$ or 0.5 V			9					pF

* On products compliant to MIL-STD-883, Class B, this parameter does not apply.

† All typical values are at $V_{CC} = 5\text{ V}$.

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ The parameters I_{OZH} and I_{OZL} include the input leakage current.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			SN54ABT16600		SN74ABT16600		UNIT
			MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency		0	150	0	150	MHz
t _w	Pulse duration	LEAB or LEBA high	2.5		2.5		ns
		CLKAB or CLKBA high or low	3		3		
t _{su}	Setup time	A before CLKAB↓ or B before CLKBA↓	3		3		ns
		A before LEAB↓ or B before LEBA↓	2.5		2.5		
		CLKEN before CLK↓	2.5		2.5		
t _h	Hold time	A after CLKAB↓ or B after CLKBA↓	0		0		ns
		A after LEAB↓ or B after LEBA↓	2		2		
		CLKEN after CLK↓	1		1		

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, T _A = 25°C			SN54ABT16600		SN74ABT16600		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f _{max}			150			150		150		MHz
t _{PLH}	A or B	B or A	1.5	2.5	3.6	1.5	4.2	1.5	4	ns
t _{PHL}			1.5	3.2	4.5	1.5	5.1	1.5	4.9	
t _{PLH}	LEAB or LEBA	B or A	2	3.2	4.5	2	5.6	2	5	ns
t _{PHL}			2	3.4	4.5	2	5.4	2	5	
t _{PLH}	CLKAB or CLKBA	B or A	2	3.5	4.7	2	5.4	2	5.3	ns
t _{PHL}			2	3.5	4.3	2	5.2	2	5	
t _{PZH}	OEAB or OEBA	B or A	1.5	3.4	4.6	1.5	5.3	1.5	5.1	ns
t _{PZL}			2	3.8	4.7	2	5.6	2	5.4	
t _{PHZ}	OEAB or OEBA	B or A	2	4.5	5.4	2	6.6	2	6.2	ns
t _{PLZ}			1.5	3.4	4.7	1.5	5.8	1.5	5.4	

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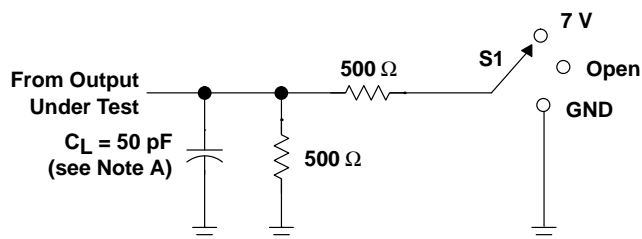
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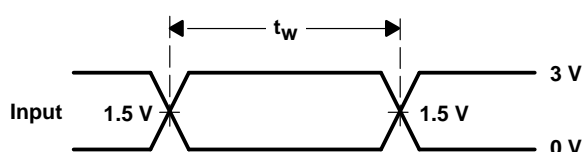
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PARAMETER MEASUREMENT INFORMATION

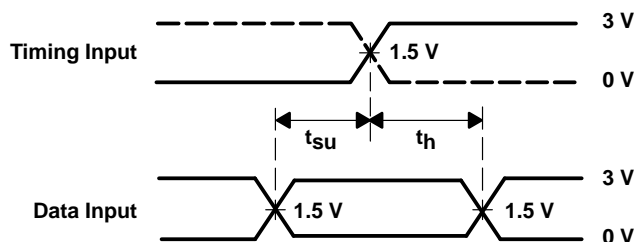


LOAD CIRCUIT FOR OUTPUTS

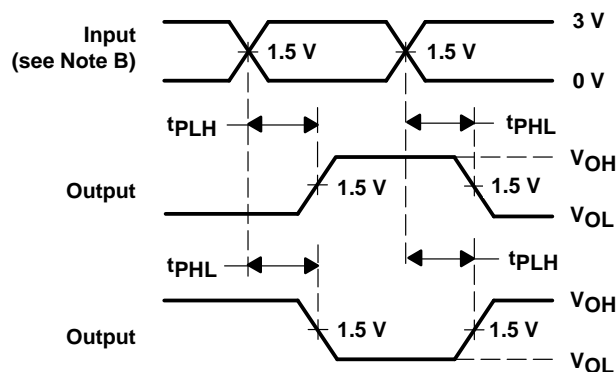
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open



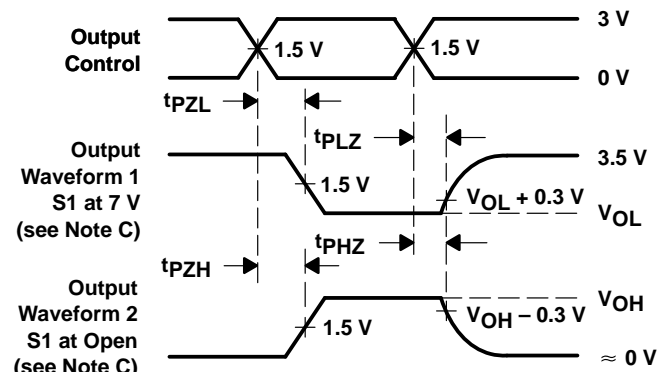
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- C_L includes probe and jig capacitance.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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